5GHz, 4-Channel MIMO Transmitter

General Description

The MAX2850 is a single-chip, 4-channel RF transmitter IC designed for 5GHz wireless HDMI applications. The IC includes all circuitry required to implement the complete 4-channel MIMO RF transmitter function and crystal oscillator, providing a fully integrated transmit path, VCO, frequency synthesis, and baseband/control interface. It includes a fast-settling, sigma-delta RF fractional synthesizer with 76Hz frequency programming step size. The IC also integrates on-chip I/Q amplitude and phase-error calibration circuits. Dynamic on/off control of four external PAs is implemented with programmable precision voltages. A 4-to-1 analog mux routes external PA power-detect voltages to the RSSI pin.

On-chip monolithic filters are included for transmitter I/Q baseband signal reconstruction to support both 20MHz and 40MHz RF channels. The baseband filtering and Tx signal paths are optimized to meet stringent WHDI requirements. The upconverter local oscillator is coherent among all the transmitter channels.

The reverse-link control channel uses an on-chip 5GHz OFDM receiver. It shares the RF synthesizer and LO generation circuit with the MIMO transmitters. The receiver includes both an in-channel RSSI and an RF RSSI.

The MIMO transmitter chip is housed in a small, 68-pin thin QFN leadless plastic package with exposed pad.

Applications

- 5GHz Wireless HDMI (WHDI)
- 5GHz FDD Backhaul and WiMax™
- 5GHz MIMO Transmitter Up to Four Spatial Streams
- 5GHz Beam Steering Transmitter

Features

- 5GHz 4x MIMO Downlink Transmitters, Single Uplink IEEE 802.11a Receiver
 - 4900MHz to 5900MHz Frequency Range
 - -5dBm Transmit Power (54Mbps OFDM)
 - Coherent LO Among Transmitters
 - 31dB Tx Gain-Control Range with 0.5dB Step Size, Digitally Controlled
 Tx/Rx I/Q Error and I Q Leakage Detection and
 - Tx/Rx I/Q Error and LO Leakage Detection and Adjustment
 - Programmable 20MHz/40MHz Tx I/Q Lowpass Anti-Aliasing Filter
 - · 4-to-1 Analog Mux for PA Power Detect
 - · 4-Channel PA On/Off Control
 - · 4.5dB Rx Noise Figure
 - 70dB Rx Gain-Control Range with 2dB Step Size, Digitally Controlled
 - 60dB Dynamic Range Receiver RSSI
 - · RF Wideband Receiver RSSI
 - Programmable 20MHz/40MHz Rx I/Q Lowpass Channel Filters
 - Sigma-Delta Fractional-N PLL with 76Hz Resolution
 - Monolithic Low-Noise VCO with -35dBc Integrated Phase Noise
 - 4-Wire SPI™ Digital Interface
 - I/Q Analog Baseband Interface
 - Digital Tx/Rx Mode Control
 - On-Chip Digital Temperature Sensor Readout
 - · Complete Baseband Interface
 - · Digital Tx/Rx Mode Control
- +2.7V to +3.6V Supply Voltage
- Small, 68-Pin Thin QFN Package (10mm x 10mm)

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX2850ITK+	-25°C to +85°C	68 Thin QFN-EP*

^{*}EP = Exposed pad.

Typical Operating Circuit appears at end of data sheet.

WiMax is a trademark of WiMax Forum. SPI is a trademark of Motorola, Inc.



⁺Denotes a lead(Pb)-free/RoHS-compliant package.

Absolute Maximum Ratings

V _{CC} Pins to GND	0.3V to +3.9V	Digital Inputs: ENABLE, CS,	
RF Inputs Maximum Current: RXRF+, RX		SCLK, DIN to GND0.3V to V _C	C + 0.3V
to GND	1mA to +1mA	Digital Outputs: DOUT, CLKOUT to GND0.3V to VC	C + 0.3V
RF Outputs: TXRF1+, TXRF1-, TXRF2+,	TXRF2-, TXRF3+,	Short-Circuit Duration	_
TXRF3-, TXRF4+, TXRF4- to GND	0.3V to V_{CC} + 0.6V	Analog Outputs	10s
Analog Inputs: TXBB1I+, TXBB1I-, TXBE	31Q+,	Digital Outputs	10s
TXBB1Q-, TXBB2I+, TXBB2I-, TXBB2	Q+,TXBB2Q-,	RF Input Power	+10dBm
TXBB3I+, TXBB3I-, TXBB3Q+, TXBB3	3Q-,	RF Output Differential Load VSWR	6:1
TXBB4I+, TXBB4I-, TXBB4Q+, TXBB4	łQ-, PA_DET1,	Continuous Power Dissipation (T _A = +85°C)	
PA_DET2, PA_DET3, PA_DET4, XTAI	-,	68-Pin Thin QFN (derate 29.4mW/°C above +70°C).	.2352mW
XTAL_CAP to GND	0.3V to V_{CC} + 0.3V	Operating Temperature Range25°C	to +85°C
Analog Outputs: RXBBI+, RXBBI-, RXBB	3Q+,	Junction Temperature	+150°C
RXBBQ-, RSSI, CLKOUT2, VCOBYP,	CPOUT+,	Storage Temperature Range65°C t	o +160°C
CPOUT-, PA_BIAS1, PA_BIAS2,		Lead Temperature (soldering, 10s)	+300°C
PA_BIAS3, PA_BIAS4 to GND	0.3V to V_{CC} + 0.3V	Soldering Temperature (reflow)	+260°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



DC Electrical Characteristics

(Operating conditions, unless otherwise specified: $V_{CC} = 2.7V \sim 3.6V$, ENABLE set according to operating mode, \overline{CS} = high, SCLK = DIN = low, transmitter in maximum gain, $T_A = -25^{\circ}C$ to +85°C. Power matching and termination for the differential RF output pins using the *Typical Operating Circuit*. 100mV_{RMS} differential I and Q signals applied to I/Q baseband inputs of transmitters in transmit mode. Typical values measured at $V_{CC} = 2.85V$, $T_A = +25^{\circ}C$, LO frequency = 5.35GHz, $T_A = +25^{\circ}C$. Channel bandwidth is set to 40MHz. PA control pins open circuit, V_{CC} PA BIAS is disconnected.) (Note 1)

PARAMETERS	CONDITIONS		MIN	TYP	MAX	UNITS
Supply Voltage, V _{CC}			2.7		3.6	V
	Shutdown mode	T _A = +25°C		10		μA
	Cleak aut ank made	XTAL oscillator, load = 10pF		3		
	Clock-out only mode	TCXO input, load = 10kΩ 10pF		7.4	11]
	Standby mode			60	89	1
0 1 0 1	T	One transmitter is on		188	235	mA
Supply Current	Transmit mode	Four transmitters are on		505	661	
	Receive mode			135	174	1
	Transmit calibration	One transmitter is on		214	261	1
	mode	Four transmitters are on		532	686	
	Receive calibration mo	ode		268	327	1
Rx I/Q Output Common-Mode Voltage			0.9	1.1	1.3	V
Tx Baseband Input Common- Mode Voltage Operating Range			0.5		1.1	V
Tx Baseband Input Bias Current	Source current			10	20	μA

Electrical Characteristics (continued)

(Operating conditions, unless otherwise specified: $V_{CC} = 2.7V \sim 3.6V$, ENABLE set according to operating mode, \overline{CS} = high, SCLK = DIN = low, transmitter in maximum gain, $T_A = -25^{\circ}C$ to +85°C. Power matching and termination for the differential RF output pins using the *Typical Operating Circuit*. 100mV_{RMS} differential I and Q signals applied to I/Q baseband inputs of transmitters in transmit mode. Typical values measured at $V_{CC} = 2.85V$, $T_A = +25^{\circ}C$, LO frequency = 5.35GHz, $T_A = +25^{\circ}C$. Channel bandwidth is set to 40MHz. PA control pins open circuit, V_{CC} PA BIAS is disconnected.) (Note 1)

PARAMETERS	CONDITIONS	MIN	TYP	MAX	UNITS
LOGIC INPUTS: ENABLE, SCLK,	DIN, CS				
Digital Input-Voltage High, V _{IH}		V _{CC} - 0.4			V
Digital Input-Voltage Low, V _{IL}				0.3	V
Digital Input-Current High, I _{IH}		-1		+1	μA
Digital Input-Current Low, I _{IL}		-1		+1	μA
LOGIC OUTPUTS: DOUT, CLKOU	JT				
Digital Output-Voltage High, V _{OH}	Sourcing 1mA	V _{CC} - 0.4			V
Digital Output-Voltage Low, V _{OL}	Sinking 1mA			0.4	V
Digital Output Voltage in Shutdown Mode	Sinking 1mA		V _{OL}		V

AC Electrical Characteristics—Rx Mode

(Operating conditions, unless otherwise specified: V_{CC} = 2.7V~3.6V, RF frequency = 5.351GHz, T_A = -25°C to +85°C. LO frequency = 5.35GHz. Reference frequency = 40MHz, ENABLE = high, \overline{CS} = high, SCLK = DIN = low, with power matching at RXRF+ and RXRF-differential ports using the *Typical Operating Circuit*. Receiver I/Q output at 100mV_{RMS} loaded with 10k Ω differential load resistance and 10pF load capacitance. The RSSI pin is loaded with 10k Ω load resistance to ground. Typical values measured at V_{CC} = 2.85V, channel bandwidths of 40MHz, T_A = +25°C.) (Note 1)

PARAMETER	CONDITIONS		TYP	MAX	UNITS		
RECEIVER SECTION: RF INPUT	RECEIVER SECTION: RF INPUT TO I/Q BASEBAND LOADED OUTPUT (INCLUDES 50Ω TO 100Ω RF BALUN AND MATCHI						
RF Input Frequency Range		4.9		5.9	GHz		
Peak-to-Peak Gain Variation over RF Frequency Range at One Temperature	4.9GHz to 5.35GHz		0.3	2.6	dB		
	5.35GHz to 5.9GHz		2.2	5.3	ub		
RF Input Return Loss	All LNA settings		-6		dB		
Total Voltage Gain	Maximum gain; Main address 1 D7:0 = 11111111	61	68		dB		
	Minimum gain; Main address 1 D7:0 = 00000000		-2	+5] ub		
	Main address 1 D7:D5 = 110		-8				
RF Gain Steps Relative to	Main address 1 D7:D5 = 101		-16		-10		
Maximum Gain	Main address 1 D7:D5 = 001		-32		dB		
	Main address 1 D7:D5 = 000		-40				
Baseband Gain Range	From maximum baseband gain (Main address 1 D3:D0 = 1111) to minimum baseband gain (Main address 1 D3:D0 = 0000)	27.5	30	32.5	dB		
Baseband Gain Step			2		dB		
RF Gain Change Settling Time	Gain settling to within ±0.5dB of steady state; RXHP = 1		400		ns		

AC Electrical Characteristics—Rx Mode (continued)

(Operating conditions, unless otherwise specified: V_{CC} = 2.7V~3.6V, RF frequency = 5.351GHz, T_A = -25°C to +85°C. LO frequency = 5.35GHz. Reference frequency = 40MHz, ENABLE = high, \overline{CS} = high, SCLK = DIN = low, with power matching at RXRF+ and RXRF-differential ports using the *Typical Operating Circuit*. Receiver I/Q output at 100mV_{RMS} loaded with 10k Ω differential load resistance and 10pF load capacitance. The RSSI pin is loaded with 10k Ω load resistance to ground. Typical values measured at V_{CC} = 2.85V, channel bandwidths of 40MHz, T_A = +25°C.) (Note 1)

PARAMETER	Co	ONDITIONS	MIN	TYP	MAX	UNITS
Baseband Gain-Change Settling Time	Gain settling to within ±0	0.5dB of steady state; RXHP = 1		200		
	Balun input referred, integrated from 10kHz to 9.5MHz at I/Q	Maximum RF gain (Main address 1 D7:D5 = 111)		4.5		
DSB Noise Figure	baseband output for 20MHz RF bandwidth	Maximum RF gain - 16dB (Main address 1 D7:D5 = 101)		15		dB
DOD NOISE I Igure	Balun input referred, integrated from 10kHz to 19MHz at I/Q	Maximum RF gain (Main address 1 D7:D5 = 111)		4.5		
	baseband output for 40MHz RF bandwidth	Maximum RF gain - 16dB (Main address 1 D7:D5 = 101)		15		
	20MHz RF channel:	-65dBm wanted signal; RF gain = max (Main address 1 D7:D0 = 11101001)		-13		
	two tone jammers at +25MHz and +48MHz frequency offset with -39dBm/tone	-49dBm wanted signal; RF gain = max - 16dB (Main address 1 D7:D0 = 10101001)		-5		
		-45dBm wanted signal; RF gain = max - 32dB (Main address 1 D7:D0 = 00111111)		11		15.
Out-of-Band Input IP3		-65dBm wanted signal; RF gain = max (Main address 1 D7:D0 = 11101001)		-13		dBm
	two tone jammers at +50MHz and +96MHz frequency offset with	-49dBm wanted signal; RF gain = max - 16dB (Main address 1 D7:D0 = 10101001)		-5		
	-39dBm/tone	-45dBm wanted signal; RF gain = max - 32dB (Main address 1 D7:D0 = 00101001)		11		
1dB Gain Desensitization by	Blocker at ±40MHz offse channel	et frequency for 20MHz RF		-24		-ID
Alternate Channel Blocker	Blocker at ±80MHz offse channel	et frequency for 40MHz RF		-24		dBm
	Max RF gain (Main addı	ress 1 D7:D5 = 111)		-32		
Input 1dB Gain Compression	Max RF gain - 8dB (Mai	n address 1 D7:D5 = 110)		-24		dBm
Inpactab Can Compression	Max RF gain - 16dB (Ma	ain address 1 D7:D5 = 101)		-16		d d d
	Max RF gain - 32dB (Ma	ain address 1 D7:D5 = 001)		0		
Output 1dB Gain Compression	Over passband frequence compression point	cy range; at any gain setting; 1dB		0.63		V _{P-P}

AC Electrical Characteristics—Rx Mode (continued)

(Operating conditions, unless otherwise specified: V_{CC} = 2.7V~3.6V, RF frequency = 5.351GHz, T_A = -25°C to +85°C. LO frequency = 5.35GHz. Reference frequency = 40MHz, ENABLE = high, \overline{CS} = high, SCLK = DIN = low, with power matching at RXRF+ and RXRF-differential ports using the *Typical Operating Circuit*. Receiver I/Q output at 100mV_{RMS} loaded with 10k Ω differential load resistance and 10pF load capacitance. The RSSI pin is loaded with 10k Ω load resistance to ground. Typical values measured at V_{CC} = 2.85V, channel bandwidths of 40MHz, T_A = +25°C.) (Note 1)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Baseband -3dB Lowpass Corner	Main address 0 D1 = 0		9.5		MHz
Frequency	Main address 0 D1 = 1		19		IVITZ
Baseband Filter Stopband	Rejection at 30MHz offset frequency for 20MHz channel	57	70		- dB
Rejection	Rejection at 60MHz offset frequency for 40MHz channel	57	70		ab
Baseband -3dB Highpass Corner Frequency	Main address 5 D1 = 1		600		kHz
	Main address 5 D1 = 0		10		KIZ
Steady-State I/Q Output DC Error with AC-Coupling	50µs after enabling receive mode and toggling RxHP from 1 to 0, averaged over many measurements if I/Q noise voltage exceeds 1mV _{RMS} , at any given gain setting, no input signal, 1-sigma value		2		mV
I/Q Gain Imbalance	1MHz baseband output, 1-sigma value		0.1		dB
I/Q Phase Imbalance	1MHz baseband output, 1-sigma value		0.2		degrees
Sideband Suppression	1MHz baseband output (Note 2)		40		dB
	LO frequency		-75		
Receiver Spurious Signal	2 x LO frequency		-62		dBm/
Emissions	3 x LO frequency		-75		MHz
	4 x LO frequency		-60		
RF RSSI Output Voltage	-20dBm input power		1.75		V
Baseband RSSI Slope		19.5	26.5	35.5	mV/dB
Baseband RSSI Maximum Output Voltage			2.3		V
Baseband RSSI Minimum Output Voltage			0.5		V
RF Loopback Conversion Gain	Tx VGA gain at maximum (Main address 9 D9:D4 = 1111111); Rx VGA gain at maximum - 24dB (Main address 1 D3:D0 = 0101)	-6	+2	+10	dB

AC Electrical Characteristics—Tx Mode

(Operating conditions, unless otherwise specified: V_{CC} = 2.7V~3.6V, RF frequency = 5.351GHz, T_A = -25°C to +85°C. LO frequency = 5.35GHz. Reference frequency = 40MHz, ENABLE = high, \overline{CS} = high, SCLK = DIN = low, with power matching at TXRF+ and TXRF- differential ports using the *Typical Operating Circuit*. 100mV_{RMS} sine and cosine signal applied to I/Q baseband inputs of transmitter (differential DC-coupled). Typical values measured at V_{CC} = 2.85V, channel bandwidths of 40MHz, T_A = +25°C.) (Note 1)

PARAMETER	CONDITIONS		TYP	MAX	UNITS	
TRANSMIT SECTION: Tx BASEBAND I/Q INPUTS TO RF OUTPUTS (INCLUDES MATCHING AND BALUN LOSS)						
RF Output Frequency Range		4.9		5.9	GHz	
Peak-to-Peak Gain Variation over RF Band	At one temperature		3	6.4	dB	

AC Electrical Characteristics—Tx Mode (continued)

(Operating conditions, unless otherwise specified: $V_{CC} = 2.7V \sim 3.6V$, RF frequency = 5.351GHz, $T_A = -25^{\circ}C$ to +85°C. LO frequency = 5.35GHz. Reference frequency = 40MHz, ENABLE = high, \overline{CS} = high, SCLK = DIN = low, with power matching at TXRF+ and TXRF-differential ports using the *Typical Operating Circuit*. 100mV_{RMS} sine and cosine signal applied to I/Q baseband inputs of transmitter (differential DC-coupled). Typical values measured at $V_{CC} = 2.85V$, channel bandwidths of 40MHz, $T_A = +25^{\circ}C$.) (Note 1)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Maximum Output Power	20MHz OFDM signal conforming to spectral emission mask and -34dB EVM	tral emission			- dBm
Maximum Output Fower	40MHz OFDM signal conforming to spectral emission mask and -34dB EVM		-4		delli
Output 1dB Gain Compression	Relative to typical maximum output power at 9.5MHz input frequency		11		dBc
Input 1dB Gain Compression	At 19MHz input frequency, over input common-mode voltage between 0.5V and 1.1V		380		mV _{RMS}
Gain-Control Range		26	31.5	34.5	dB
Gain-Control Step			0.5		dB
RF Output Return Loss			-3		dB
Unwanted Sideband	Over RF channel, RF frequency, baseband frequency, and gain settings (Note 2)		-40		dBc
Carrier Leakage	Over RF channel, RF frequency, and gain settings (Note 2)		-29	-15	dBc
Ty I/O Innut Impodence (DIIC)	Minimum differential resistance		60		kΩ
Tx I/Q Input Impedance (R C)	Maximum differential capacitance		2		pF
Baseband Filter Stopband	At 30MHz frequency offset for 20MHz RF channel		86		-ID
Rejection	At 60MHz frequency offset for 40MHz RF channel		67		- dB
Tx Calibration Ftone Level	At Tx gain code (Main address 9 D9:D4) = 100010 and -15dBc carrier leakage (Local address 27 D2:D0 = 110 and Main address 1 D3:D0 = 0000)	-28		dBV _{RMS}	
Tx Calibration Gain Range	Adjust Local address 27 D2:D0		35		dB

AC Electrical Characteristics—Frequency Synthesis

(Operating conditions, unless otherwise specified: $V_{CC} = 2.7V \sim 3.6V$, frequency = 5.35GHz, $T_A = -25^{\circ}C$ to +85°C. Reference frequency = 40MHz, ENABLE = high, \overline{CS} = high, SCLK = DIN = low. Typical values measured at V_{CC} = 2.85V, LO frequency = 5.35GHz, $T_A = +25^{\circ}C$.) (Note 1)

PARAMETER	CONDITIONS		TYP	MAX	UNITS
FREQUENCY SYNTHESIZER					
RF Channel Center Frequency		4.9		5.9	GHz
Channel Center Frequency Programming Step			76.294		Hz
Closed-Loop Integrated Phase Noise	Loop BW = 200kHz, integrate phase noise from 1kHz to 10MHz		-35		dBc
Charge-Pump Output Current			0.8		mA
Spur Loyal	f _{OFFSET} = 0 to 19MHz	-42			- dBc
Spur Level	f _{OFFSET} = 40MHz		-66		ubc
Reference Frequency			40		MHz

AC Electrical Characteristics—Frequency Synthesis (continued)

(Operating conditions, unless otherwise specified: V_{CC} = 2.7V~3.6V, frequency = 5.35GHz, T_A = -25°C to +85°C. Reference frequency = 40MHz, ENABLE = high, \overline{CS} = high, SCLK = DIN = low. Typical values measured at V_{CC} = 2.85V, LO frequency = 5.35GHz, T_A = +25°C.) (Note 1)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Reference Frequency Input Levels	AC-coupled to XTAL pin	800			mV _{P-P}
Maximum Crystal Motional Resistance			50		Ω
Crystal Capacitance Tuning Range	Base-to-ground capacitance		30		pF
Crystal Capacitance Tuning Step			140		fF
CLKOUT Signal Level	10pF load capacitance	V _{CC} - 0.8	V _{CC} - 0.1		V _{P-P}

AC Electrical Characteristics—Miscellaneous Blocks

(Operating conditions, unless otherwise specified: V_{CC} = 2.7V~3.6V, T_A = -25°C to +85°C. Reference frequency = 40MHz, ENABLE = high, \overline{CS} = high, SCLK = DIN = low. Typical values measured at V_{CC} = 2.85V, T_A = +25°C.) (Note 1)

PARAMETER	CONDITION	IS	MIN	TYP	MAX	UNITS
PA POWER DETECTOR MUX						
Output-Voltage Drop	V _{IN} = 2V, load resistance = 10kΩ	to ground		11	30	mV
PA ON/OFF CONTROL						
V _{CC_PA} Input Voltage Range			3.1		3.6	V
V _{CC_PA} Supply Current	With 10mA load at PA_BIAS1 to F	Nith 10mA load at PA_BIAS1 to PA_BIAS4 42				mA
Output High Level	10mA load current, Main address	11 D7:5 = 011		2.8		V
Output High-Level Variation Between PA_BIAS1 to PA_BIAS4				30		mV
Output Low Level	1mA load current, Main address 1	1 D7:5 = 011		25		mV
Turn-On Time	Measured from CS rising edge			0.3		μs
ON-CHIP TEMPERATURE SENSO	DR					
		T _A = +25°C		17		
Digital Output Code	Read-out at DOUT pin through Main address 3 D4:D0	T _A = +85°C		25		1
PA ON/OFF CONTROL V _{CC_PA} Input Voltage Range V _{CC_PA} Supply Current Output High Level Output High-Level Variation Between PA_BIAS1 to PA_BIAS4 Output Low Level Turn-On Time ON-CHIP TEMPERATURE SENSO	Walli addiess 5 D4.D0	T _A = -20°C		9]

AC Electrical Characteristics—Timing

(Operating conditions, unless otherwise specified: V_{CC} = 2.7V~3.6V, frequency = 5.35GHz, T_A = -25°C to +85°C,. Reference frequency = 40MHz, ENABLE = high, \overline{CS} = high, SCLK = DIN = low, typical values measured at V_{CC} = 2.85V, LO frequency = 5.35GHz, T_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
SYSTEM TIMING						
Shutdown Time				2		μs
Maximum Channel Switching Time		Loop bandwidth = 200kHz, settling to within ±1kHz from steady state		2		ms
Maximum Channel Switching Time With Preselected VCO Sub-Band		Loop bandwidth = 200kHz, settling to within ±1kHz from steady state		56		μs

AC Electrical Characteristics—Timing (continued)

(Operating conditions, unless otherwise specified: V_{CC} = 2.7V~3.6V, frequency = 5.35GHz, T_A = -25°C to +85°C,. Reference frequency = 40MHz, ENABLE = high, \overline{CS} = high, SCLK = DIN = low, typical values measured at V_{CC} = 2.85V, LO frequency = 5.35GHz, T_A = +25°C.) (Note 1)

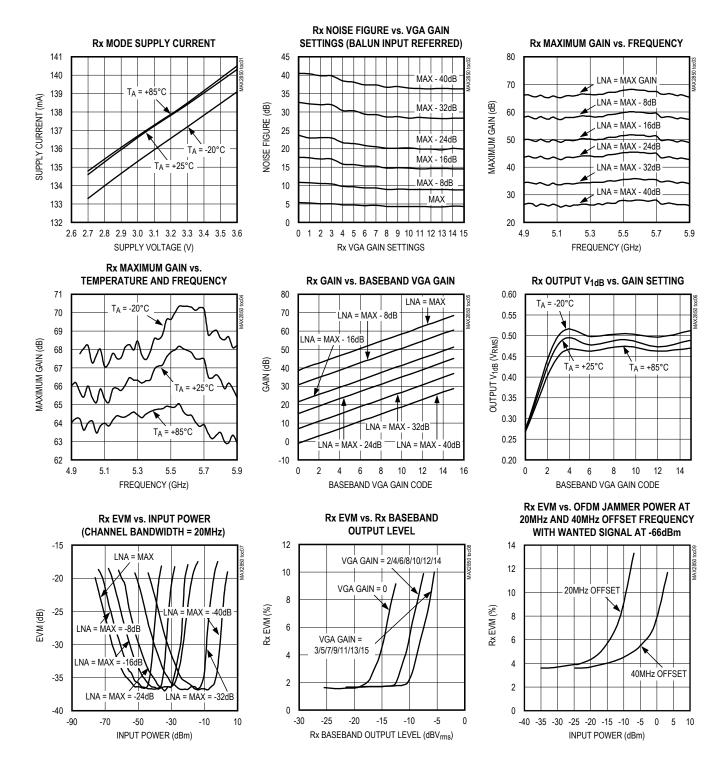
PARAMETER	SYMBOL	CONDITIONS			TYP	MAX	UNITS
		Measured	Rx to Tx mode, Tx gain settles to within 0.2dB of steady state		2		
Rx/Tx Turnaround Time		from CS rising edge	Tx to Rx mode with RXHP = 1, Rx gain settles to within 0.5dB of steady state		2		μs
Tx Turn-On Time (from Standby Mode)			m CS rising edge, Tx gain settles B of steady state		2		μs
Tx Turn-Off Time (to Standby Mode)		From CS risir	ng edge		0.1		μs
Rx Turn-On Time (from Standby Mode)			m CS rising edge, Rx gain settles B of steady state		2		μs
Rx Turn-Off Time (to Standby Mode)		From CS risir	ng edge		0.1		μs
4-WIRE SERIAL-INTERFACE	TIMING (SE	EE FIGURE 1)					
SCLK Rising Edge to $\overline{\text{CS}}$ Falling Edge Wait Time	tcso				6		ns
Falling Edge of CS to Rising Edge of First SCLK Time	tcss				6		ns
DIN to SCLK Setup Time	t _{DS}				6		ns
DIN to SCLK Hold Time	t _{DH}				6		ns
SCLK Pulse-Width High	t _{CH}				6		ns
SCLK Pulse-Width Low	t _{CL}				6		ns
Last Rising Edge of SCLK to Rising Edge of CS or Clock to Load Enable Setup Time	t _{CSH}				6		ns
CS High Pulse Width	t _{CSW}				50		ns
Time Between Rising Edge of CS and the Next Rising Edge of SCLK	t _{CS1}				6		ns
SCLK Frequency	f _{CLK}					40	MHz
Rise Time	t _R				2.5		ns
Fall Time	t _F				2.5		ns
SCLK Falling Edge to Valid DOUT	t _D				12.5		ns

Note 1: The MAX2850 is production tested at T_A = +25°C; minimum/maximum limits at T_A = +25°C are guaranteed by test, unless specified otherwise. Minimum/maximum limits at T_A = -25°C and +85°C are guaranteed by design and characterization. There is no power-on register settings self-reset; recommended register settings must be loaded after V_{CC} is applied.

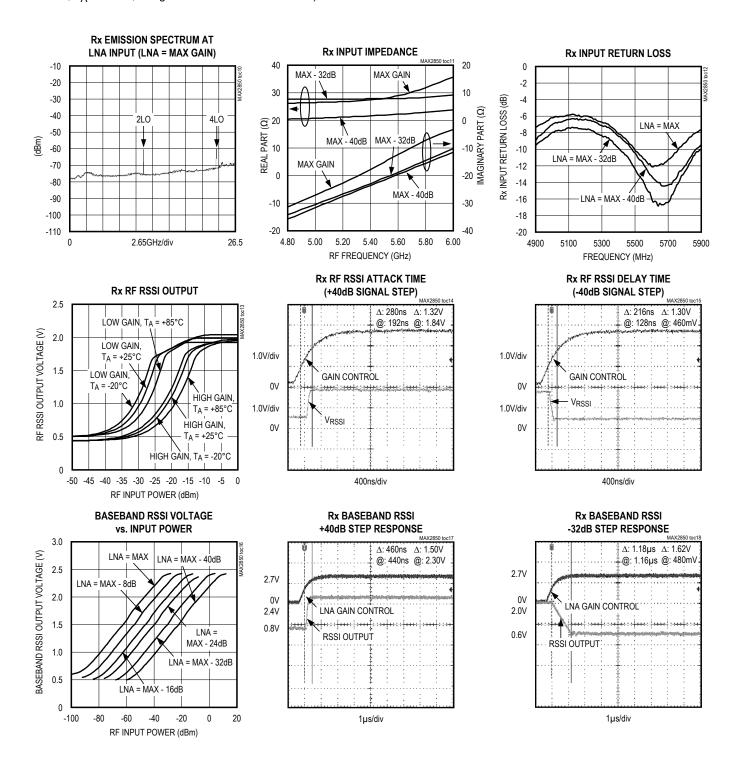
Note 2: For optimal Rx and Tx quadrature accuracy over temperature, the user can utilize the Rx calibration and Tx calibration circuit to assist quadrature calibration.

Typical Operating Characteristics

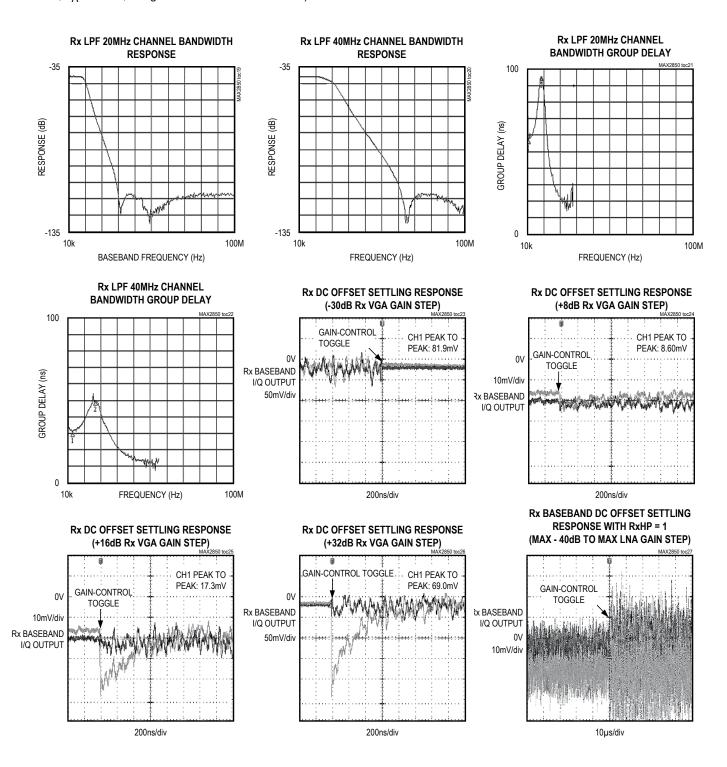
 $(V_{CC} = 2.8V, f_{LO} = 5.35 GHz, f_{REF} = 40 MHz, \overline{CS} = high, SCLK = DIN = low, RF BW = 20 MHz, Tx output at 50 \Omega unbalanced output of balun, T_A = +25°C, using the MAX2850 Evaluation Kit.)$



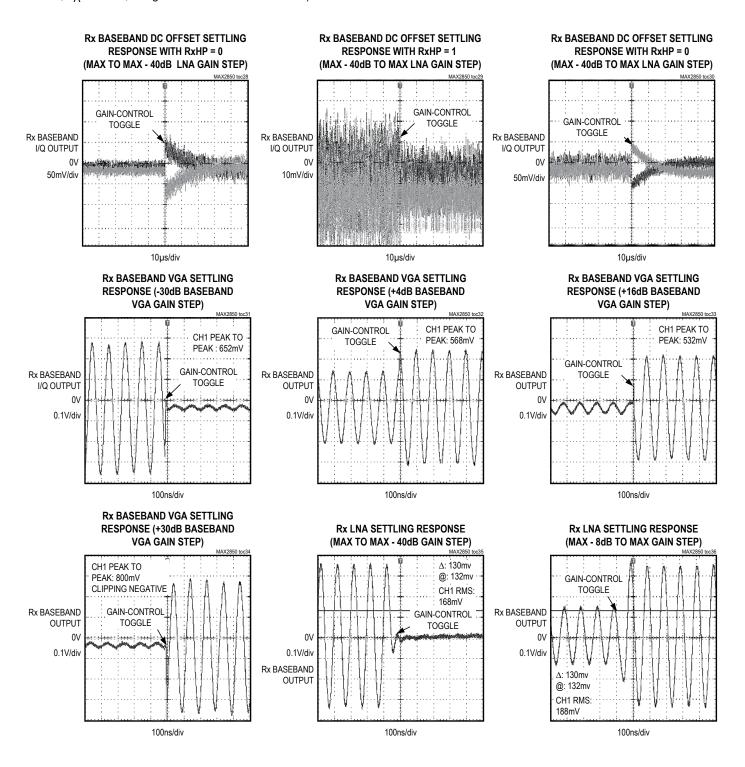
 $(V_{CC}$ = 2.8V, f_{LO} = 5.35GHz, f_{REF} = 40MHz, \overline{CS} = high, SCLK = DIN = low, RF BW = 20MHz, Tx output at 50 Ω unbalanced output of balun, T_A = +25°C, using the MAX2850 Evaluation Kit.)



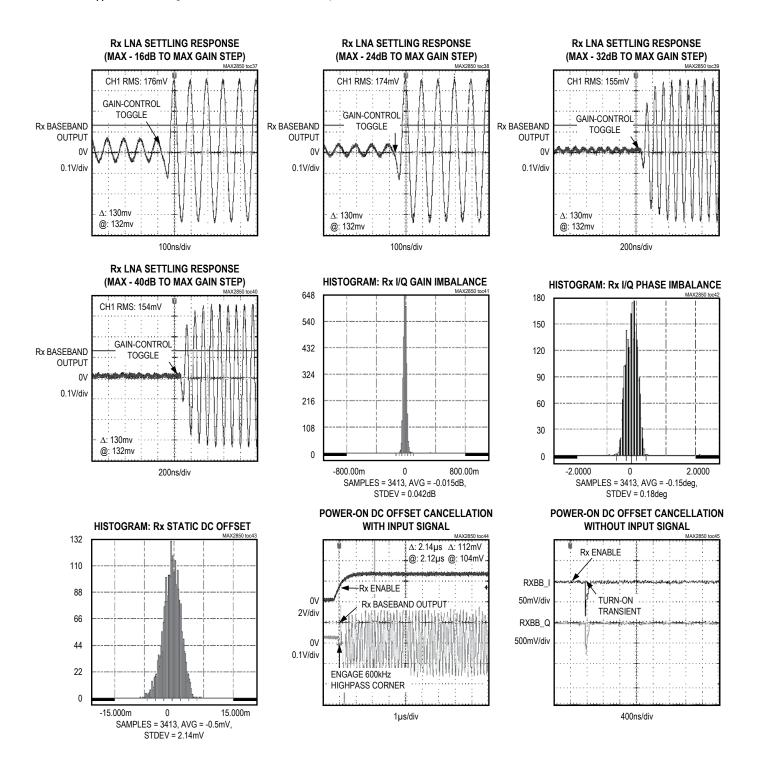
 $(V_{CC}$ = 2.8V, f_{LO} = 5.35 \overline{GHz} , f_{REF} = 40MHz, \overline{CS} = high, SCLK = DIN = low, RF BW = 20MHz, Tx output at 50 Ω unbalanced output of balun, T_A = +25°C, using the MAX2850 Evaluation Kit.)



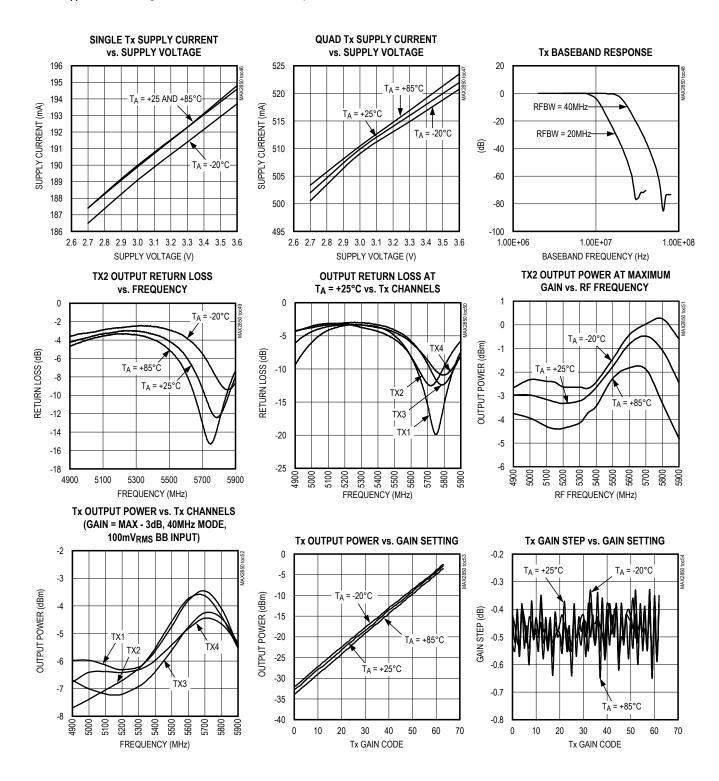
 $(V_{CC}$ = 2.8V, f_{LO} = 5.35GHz, f_{REF} = 40MHz, \overline{CS} = high, SCLK = DIN = low, RF BW = 20MHz, Tx output at 50 Ω unbalanced output of balun, T_A = +25°C, using the MAX2850 Evaluation Kit.)



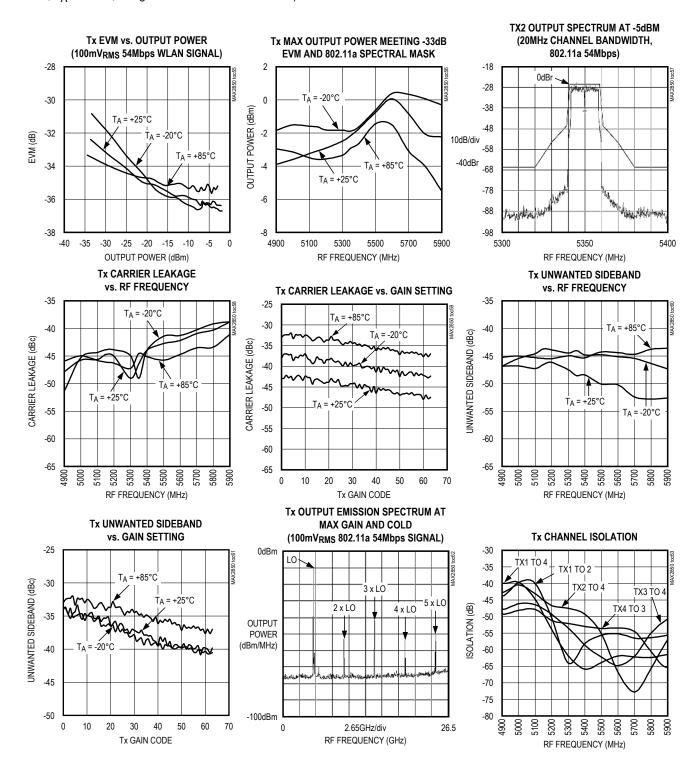
 $(V_{CC}$ = 2.8V, f_{LO} = 5.35GHz, f_{REF} = 40MHz, \overline{CS} = high, SCLK = DIN = low, RF BW = 20MHz, Tx output at 50 Ω unbalanced output of balun, T_A = +25°C, using the MAX2850 Evaluation Kit.)



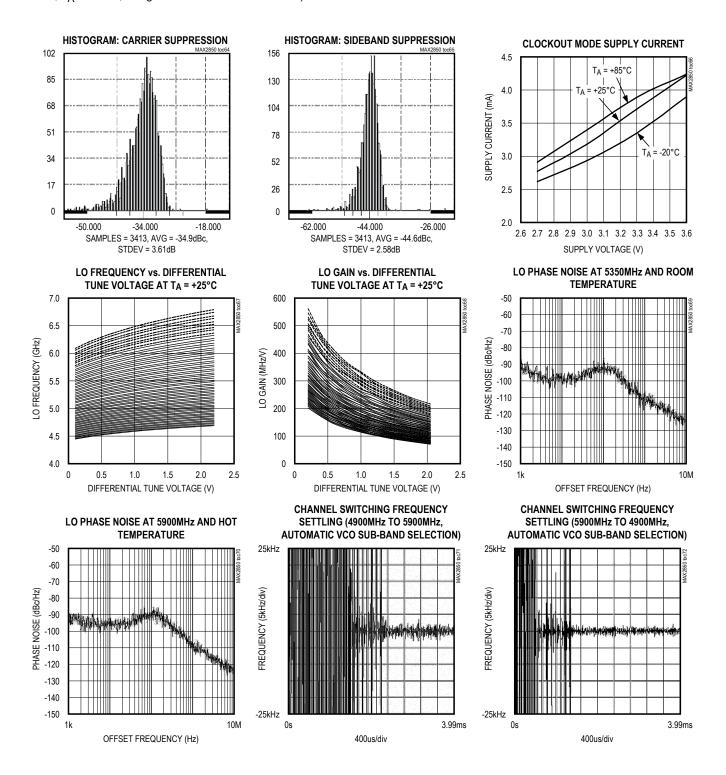
 $(V_{CC}$ = 2.8V, f_{LO} = 5.35GHz, f_{REF} = 40MHz, \overline{CS} = high, SCLK = DIN = low, RF BW = 20MHz, Tx output at 50 Ω unbalanced output of balun, T_A = +25°C, using the MAX2850 Evaluation Kit.)



 $(V_{CC}$ = 2.8V, f_{LO} = 5.35GHz, f_{REF} = 40MHz, \overline{CS} = high, SCLK = DIN = low, RF BW = 20MHz, Tx output at 50 Ω unbalanced output of balun, T_A = +25°C, using the MAX2850 Evaluation Kit.)



 $(V_{CC}$ = 2.8V, f_{LO} = 5.35GHz, f_{REF} = 40MHz, \overline{CS} = high, SCLK = DIN = low, RF BW = 20MHz, Tx output at 50 Ω unbalanced output of balun, T_A = +25°C, using the MAX2850 Evaluation Kit.)



-0.5 0

50

100

150

XTAL TUNING CODE

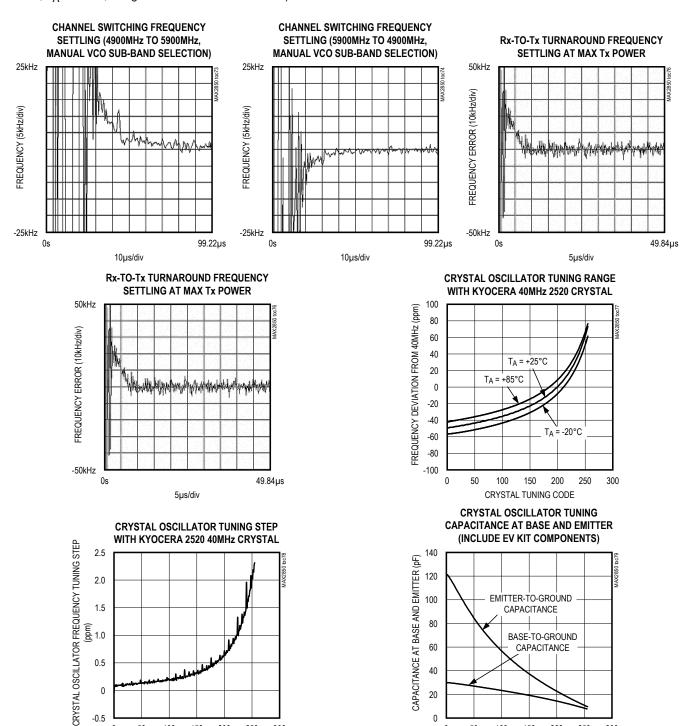
250

200

300

Typical Operating Characteristics (continued)

 $(V_{CC} = 2.8V, f_{LO} = 5.35GHz, f_{REF} = 40MHz, \overline{CS} = high, SCLK = DIN = low, RF BW = 20MHz, Tx output at 50<math>\Omega$ unbalanced output of balun, $T_A = +25$ °C, using the MAX2850 Evaluation Kit.)



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0

0

50

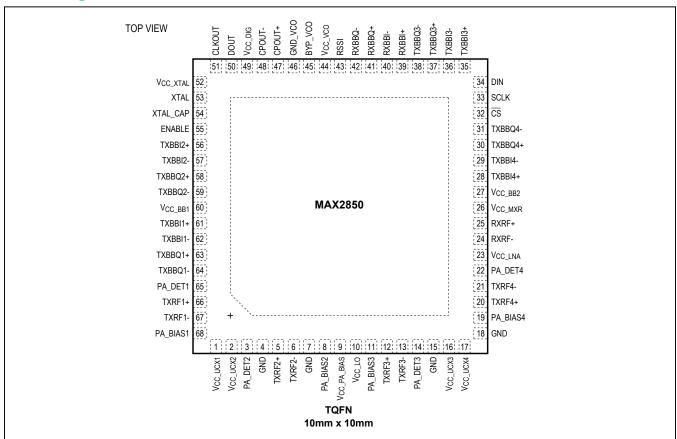
100

150

CRYSTAL TUNING CODE

200 250 300

Pin Configuration



Pin Description

PIN	NAME	FUNCTION
1	V _{CC_UCX1}	Transmitter 1 Upconverter Supply Voltage. Bypass with a capacitor as close as possible to the pin.
2	V _{CC_UCX2}	Transmitter 2 Upconverter Supply Voltage. Bypass with a capacitor as close as possible to the pin.
3	PA_DET2	External Power-Amplifier Detector Mux Input 2
4	GND	Ground
5	TXRF2+	Transmitter 2 Differential Output. These pins are in open-collector configuration. These pins should be
6	TXRF2-	biased at the supply voltage with differential impedance terminated at 300Ω .
7	GND	Ground
8	PA_BIAS2	External Power-Amplifier Voltage Bias Output 2
9	V _{CC_PA_BIAS}	External Power-Amplifier Voltage Bias and Detector Mux Supply Voltage. Bypass with a capacitor as close as possible to the pin.
10	V _{CC_LO}	LO Generation Supply Voltage. Bypass with a capacitor as close as possible to the pin.
11	PA_BIAS3	External Power-Amplifier Voltage Bias Output 3
12	TXRF3+	Transmitter 3 Differential Output. These pins are in open-collector configuration. These pins should be
13	TXRF3-	biased at the supply voltage with differential impedance terminated at 300Ω .
14	PA_DET3	External Power Amplifier Detector Mux Input 3

Pin Description (continued)

PIN	NAME	FUNCTION				
15	GND	Ground				
16	V _{CC_UCX3}	Transmitter 3 Upconverter Supply Voltage. Bypass with a capacitor as close as possible to the pin.				
17	V _{CC_UCX4}	Transmitter 4 Upconverter Supply Voltage. Bypass with a capacitor as close as possible to the pin.				
18	GND	Ground				
19	PA_BIAS4	External Power-Amplifier Voltage Bias Output 4				
20	TXRF4+	Transmitter 4 Differential Output. These pins are in open-collector configuration. These pins should be				
21	TXRF4-	biased at the supply voltage with differential impedance terminated at 300Ω .				
22	PA_DET4	External Power-Amplifier Detector Mux Input 4				
23	V _{CC LNA}	Receiver LNA Supply Voltage. Bypass with a capacitor as close as possible to the pin.				
24	RXRF-	Descriped INA Differential limit limit is DC sounded and bigged internally at 4.2V				
25	RXRF+	Receiver LNA Differential Input. Input is DC-coupled and biased internally at 1.2V.				
26	V_{CC_MXR}	Receiver Downconverter Supply Voltage. Bypass with a capacitor as close as possible to the pin.				
27	V _{CC_BB2}	Receiver Baseband Supply Voltage 2. Bypass with a capacitor as close as possible to the pin.				
28	TXBBI4+	Transmitter 4 Baseband I-Channel Differential Input				
29	TXBBI4-	Transmitter 4 Daseband 1-Onanner Dinerential Imput				
30	TXBBQ4+	Transmitter 4 Baseband Q-Channel Differential Input				
31	TXBBQ4-	Transmitter 4 Daseband Q-Onamier Dimerential imput				
32	CS	Chip-Select Logic Input of 4-Wire Serial Interface				
33	SCLK	Serial-Clock Logic Input of 4-Wire Serial Interface				
34	DIN	Data Logic Input of 4-Wire Serial Interface				
35	TXBBI3+	Transmitter 3 Baseband I-Channel Differential Input				
36	TXBBI3-	The control of the co				
37	TXBBQ3+	Transmitter 3 Baseband Q-Channel Differential Input				
38	TXBBQ3-	Transmitter of Basesbarra & Charmer Bineronitian input				
39	RXBBI+	Receiver Baseband I-Channel Differential Output				
40	RXBBI-					
41	RXBBQ+	Receiver Baseband Q-Channel Differential Output				
42	RXBBQ-	·				
43	RSSI	Receiver Signal-Strength Indicator Output				
44	V _{CC_} vco	VCO Supply Voltage. Bypass with a capacitor as close as possible to the pin.				
45	BYP_VCO	On-Chip VCO Regulator Output Bypass. Bypass with an external 1µF capacitor to GND_VCO with minimum PCB trace. Do not connect other circuitry to this pin.				
46	GND_VCO	VCO Ground				
47	CPOUT+	Differential Charge-Pump Output. Connect the frequency synthesizer's loop filter between CPOUT+ and				
48	CPOUT-	CPOUT- (see the Typical Operating Circuit).				
49	V _{CC_DIG}	Digital Block Supply Voltage. Bypass with a capacitor as close as possible to the pin.				
50	DOUT	Data Logic Output of 4-Wire Serial Interface				
51	CLKOUT	Reference Clock Buffer Output				
52	V _{CC_XTAL}	Crystal Oscillator Supply Voltage. Bypass with a capacitor as close as possible to the pin.				
53	XTAL	Crystal Oscillator Base Input. AC-couple crystal unit to this pin.				
54						
53						

Pin Description (continued)

PIN	NAME	FUNCTION
56	TXBBI2+	Transmitter 2 Reschand I Channel Differential Input
57	TXBBI2-	Transmitter 2 Baseband I-Channel Differential Input
58	TXBBQ2+	Transmitter 2 Beach and O Channel Differential Innut
59	TXBBQ2-	Transmitter 2 Baseband Q-Channel Differential Input
60	V _{CC_BB1}	Receiver Baseband Supply Voltage 1. Bypass with a capacitor as close as possible to the pin.
61	TXBBI1+	Townsides A Deach and I Observed Differential leaves
62	TXBBI1-	Transmitter 1 Baseband I-Channel Differential Input
63	TXBBQ1+	Transmitter 4 Beachand O Channel Differential Innut
64	TXBBQ1-	Transmitter 1 Baseband Q-Channel Differential Input
65	PA_DET1	External Power-Amplifier Detector Mux Input 1
66	TXRF1+	Transmitter 1 Differential Output. These pins are in open-collector configuration. These pins should be
67	TXRF1-	biased at the supply voltage with differential impedance terminated at 300Ω .
68	PA_BIAS1	External Power-Amplifier Voltage Bias Output 1
_	EP	Exposed Pad. Connect to the ground plane with multiple vias for proper operation and heat dissipation. Do not share with any other pin grounds and bypass capacitors' ground.

Table 1. Operating Modes

	_	ONTROL INPUTS	CIRCUIT BLOCK STATES							
MODE	ENABLE PIN	SPI MAIN ADDRESS 0, D4:D2	Rx PATH	Tx PATH (Note 4)	LO PATH	CLKOUT (Note 5)	Calibration Sections On			
SHUTDOWN	0	XXX	Off	Off	Off	Off	None			
CLKOUT	1	000	Off	Off	Off	On	None			
STANDBY	1	001	Off	Off	On	On	None			
Rx	1	010	On	Off	On	On	None			
Tx	1	011	Off	On	On	On	None			
Tx CALIBRATION	CALIBRATION 1 100		Off	On	On	On	AM detector + Rx I/Q buffers			
RF LOOPBACK	1	101	On (except LNA)	On	On	On	RF loopback			
BASEBAND LOOPBACK	1	11X	On (except RXRF)	Off	On	On	Tx 4 baseband buffer			

Note 4: PA_BIAS pins may be kept active in nontransmit mode(s) by SPI programming.

Note 5: CLKOUT signal is active independent of SPI, and is only dependent on the ENABLE pin.

Detailed Description

Modes of Operation

The modes of operation for the MAX2850 are shutdown, clockout, standby, receive, transmit, transmitter calibration, RF loopback, and baseband loopback. See Table 1 for a summary of the modes of operation. The logic input

pin ENABLE (pin 55) and SPI Main address 0 D4:D2 control the various modes.

Shutdown Mode

The MAX2850 features a low-power shutdown mode. All circuit blocks are powered down, except the 4-wire serial bus and its internal programmable registers.

Clockout Mode

In clockout mode, only the crystal oscillator signal is active at the CLKOUT pin. The rest of the transceiver is powered down.

Standby Mode

In standby mode, PLL, VCO, and LO generation are on. Tx or Rx modes can be quickly enabled from this mode. Other blocks may be selectively enabled in this mode.

Receive (Rx) Mode

In receive mode, all Rx circuit blocks are powered on and active. Antenna signal is applied; RF is down-converted, filtered, and buffered at Rx baseband I and Q outputs.

Transmit (Tx) Mode

In transmit mode, all Tx circuit blocks are powered on and active. The external PA can be powered on through the PA BIAS pins after a programmable delay.

Transmit Calibration

In transmit calibration mode, all Tx circuit blocks are powered on and active. The AM detector and receiver I/Q channel buffers are also on. Output signals are routed to Rx baseband I and Q outputs.

The AM detector multiplies the Tx RF output signal with itself. The self-mixing product of the wanted sideband becomes DC voltage and is filtered on-chip. The mixing product between wanted sideband and the carrier leakage forms Ftone at Rx baseband output. The mixing product between the wanted sideband and the unwanted sideband forms 2Ftone at Rx baseband output.

As Tx RF output is self-mixed at the AM detector, the AM detector output responds differently to different gain settings and power levels. When Tx RF output power changes by 1dB through Tx gain control, the AM detector output changes by 2dB as both the wanted sideband and carrier leakage (or unwanted sideband) change by 1dB. When Tx RF output carrier leakage (or unwanted sideband) changes by 1dB while the wanted sideband output power is constant, the AM detector output changes by 1dB only.

RF Loopback

In RF loopback mode, part of the Rx and Tx circuit blocks except the LNA are powered on and active. The transmitter 4 I/Q input signal is upconverted to RF, and the output of the transmitter is fed to the receiver down-converter input. Output signals are delivered to receiver 4 baseband I/Q outputs. The I/Q lowpass filters in the transmitter signal path are bypassed.

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Baseband Loopback

In baseband loopback mode, part of the Rx and Tx baseband circuit blocks are powered and active. The transmitter 4 I/Q input signal is routed to receiver lowpass filter input. Output signals are delivered to receiver 4 baseband I/Q outputs.

Power-On Sequence

Set the ENABLE pin to V_{CC} for 2ms to start the crystal oscillator. Program all SPI addresses according to recommended values. Set SPI Main address 0 D4:D2 from 000 to 001 to engage standby mode. To lock the LO frequency, the user can set SPI in order of Main address 15, Main address 16, and then Main address 17 to trigger VCO sub-band autoacquisition; the acquisition will take 2ms. After the LO frequency is locked, set SPI Main address 0 D4:D2 = 010 and 011 for Rx and Tx operating modes, respectively. Before engaging Rx mode, set Main address 5 D1 = 1 to allow fast DC offset settling. After engaging Rx mode and Rx baseband DC offset settles, the user can set Main address 5 D1 = 0 to complete Rx DC offset cancellation.

Programmable Registers and 4-Wire SPI Interface

The MAX2850 includes 60 programmable 16-bit registers. The most significant bit (MSB) is the read/write selection bit (R/W in Figure 1). The next 5 bits are register address (A4:A0 in Figure 1). The 10 least significant bits (LSBs) are register data (D9:D0 in Figure 1). Register data is loaded through the 4-wire SPI/MICROWIRE™compatible serial interface. MSB of data at the DIN pin is shifted in first and is framed by \overline{CS} . When \overline{CS} is low, the clock is active, and input data is shifted at the rising edge of the clock at SCLK pin. At the CS rising edge, the 10-bit data bits are latched into the register selected by address bits. See Figure 1. To support more than a 32-register address using a 5-bit wide address word, the bit 0 of address 0 is used to select whether the 5-bit address word is applied to the main address or local address. The register values are preserved in shutdown mode as long as the power-supply voltage is maintained. There is no power-on SPI register self-reset functionality in the MAX2850, so the user must program all register values after power-up. During the read mode, register data selected by address bits is shifted out to the DOUT pin at the falling edges of the clock.

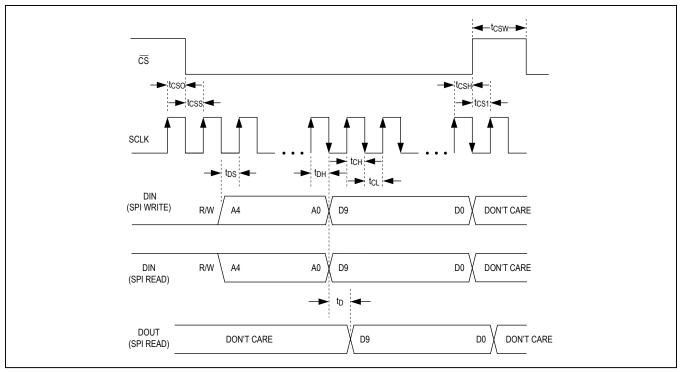


Figure 1. 4-Wire SPI Serial-Interface Timing Diagram

SPI Register Definition

(All values in the register summary table are typical numbers. The MAX2850 SPI does not have a power-on-default self-reset feature; the user must program all SPI addresses for normal operation. Prior to use of any untested settings, contact the factory.)

Table 2. MAX2850 Register Summary

	READ/WRITE AND ADDRESS			DATA											
REGISTER	Main0_ D0	A4:A0	WRITE (W)/ READ (R)	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0		
Main0	0	W/R				E_TX	<4:1>			MODE<2:0>		RFBW	M/L_SEL		
IVIAIIIU	0 00000	0 00000	00000	Default	0	1	1	1	1	0	0	0	1	0	
Main1	0	0 00001 W/R		RESERVED	RESERVED LNA_GAIN<2:0>				RX_VGA<4:0>						
IVIAIITI	"	00001	00001	Default	0	0	1	1	1	1	1	1	1	1	
Main2	0	00010	W/R	RESERVED	RESERVED	RESERVED	LNA_BA	ND<1:0>	RESERVED	RESERVED	RESERVED	RESERVED	RESERVED		
IVIAII1Z		0 0	0	0	0 00010	Default	0	1	1	0	1	0	0	0	0
			W	RESERVED	RESERVED	TO EN	TS TRIG	RESERVED	RESERVED	RESERVED RESERVED R		RESERVED	RESERVED		
Main3	0 00011	00011	R RESERVED RESERVED	TS_EN	13_IRIG	RESERVED	TS_READ<4:0>								
			Default	0	0	0	0	0	0	0	0	0	0		

Table 2. MAX2850 Register Summary (continued)

	READ/\	WRITE AN	D ADDRESS					DA	TA				
REGISTER	Main0_ D0	A4:A0	WRITE (W)/ READ (R)	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
Main4	0	00100	Reserved	1	1	0	0	0	1	1	1	0	0
MainE	0	00404	W/R	RESERVED	RSS	I_MUX_SEL<	:2:0>	RESERVED	RESERVED	RESERVED	RESERVED	RXHP	RESERVED
Main5	5 0 0010	00101	Default	0	0	0	0	0	0	0	0	0	0
Main6	0	00110	Reserved	1	1	1	1	1	0	1	0	0	0
Main7	0	00111	Reserved	0	0	0	0	1	0	0	1	0	0
Main8	0	01000	W/R	0	0	0	0	0	0	0	0	0	0
Main9	0	01001	W/R			TX_GA	IN<5:0>			7	TX_GAIN_PRO	OG_SEL<4:1>	
IVIAII19	0	01001	Default	0	0	0	0	0	0	1	1	1	1
Main10	0	01010	Reserved	0	0	0	0	0	0	0	0	0	0
Main11	0	01011	W/R	RESERVED	RESERVED	RESERVED	RESERVED	RESERVED	RESERVED	E_TX_A	MD<1:0>	PA_DET_	SEL<1:0>
IVIAIITT	0	01011	Default	0	0	0	1	1	0	0	0	0	0
Main13	0	01101	Reserved	0	0	0	0	0	0	0	0	0	0
Main14	0	01110	W/R	RESERVED	RESERVED	RESERVED	RESERVED	RESERVED	RESERVED	RESERVED	RESERVED	DOUT_SEL	RESERVED
IVIAII114	0	01110	Default	0	1	0	1	1	0	0	0	0	0
Main15	0	01111	W/R	VAS_ TRIG_EN	RESE	RVED			SYN	SYN_CONFIG_N<6:0>			
			Default	1	0	0	1	0	0	0	0	1	0
Main 16		10000	W/R			·		SYN_CONFI	G_F<19:10>				
Main16	6 0 10000		Default	1	1	1	0	0	0	0	0	0	0
M-i-47	0 4000	40004	W/R					SYN_CONF	IG_F<9:0>				
Main17	0	10001	Default	0	0	0	0	0	0	0	0	0	0
Main 10	0	10010	W/R	RESERVED	RESERVED				XTAL_TU	NE<7:0>			
Main18	0	10010	Default	0	0	1	0	0	0	0	0	0	0
Main19	0	10011	W/R	RESERVED	RVED RESERVED RELOCK_ SEL WAS_ VAS_ VAS_SPI<5:0>								
			Read		V	AS_ADC<2:0	>			VCO_BAN	ND<5:0>		
			Default	0	0	0	1	0	1	1	1	1	1
Main20	0	10100	Reserved	0	1	1	1	1	0	1	0	1	0
Main21	0	10101	Read	RESERVED	RESERVED		DIE_ID<2:0>	•	RESERVED	RESERVED	RESERVED	RESERVED	RESERVED
IVIAII1Z I		10101	Default	0	0	1	0	1	1	1	1	1	1
Main22	0	10110	Reserved	0	1	1	0	1	1	1	0	0	0
Main23	0	10111	Reserved	0	0	0	1	1	0	0	1	0	1
Main24	0	11000	Reserved	1	0	0	1	0	0	1	1	1	1
Main25	0	11001	Reserved	1	1	1	0	1	0	1	0	0	0
Main26	0	11010	Reserved	0	0	0	0	0	1	0	1	0	1
Main27	0	11011	W/R	DIE_ID_ READ	RESERVED	RESERVED	RESERVED	VAS_VCO_ READ	RESERVED	RESERVED	RESERVED	RESERVED	RESERVED
			Default	0	1	1	0	0	0	0	0	0	0
Main28	0	11100	W/R	RESERVED	RESERVED	RESERVED	RESERVED	RESERVED	RESERVED		PA_BIAS_	DLY<3:0>	
ıvıaın∠ö U	11100	Default	0	0	0	1	1	0	0	0	1	1	

Table 2. MAX2850 Register Summary (continued)

	READ/	WRITE AN	D ADDRESS					DA	.TA				
REGISTER	Main0_ D0	A4:A0	WRITE (W)/ READ (R)	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
Main29	0	11101	Reserved	0	0	0	0	0	0	0	0	0	0
Main30	0	11110	Reserved	0	0	0	0	0	0	0	0	0	0
Main31	0	11111	Reserved	0	0	0	0	0	0	0	0	0	0
Local1	1	00001	Reserved	0	0	0	0	0	0	0	0	0	0
Local2	1	00010	Reserved	0	0	0	0	0	0	0	0	0	0
Local3	1	00011	Reserved	0	0	0	0	0	0	0	0	0	0
Local4	1	00100	Reserved	1	1	1	0	0	0	0	0	0	0
Local5	1	00101	Reserved	0	0	0	0	0	0	0	0	0	0
Local6	1	00110	Reserved	0	0	0	0	0	0	0	0	0	0
Local7	1	00111	Reserved	0	0	0	0	0	0	0	0	0	0
Local8	1	01000	Reserved	0	1	1	0	1	0	1	0	1	0
Local9	1	01001	Reserved	0	1	0	0	0	1	0	1	0	0
Local10	1	01010	Reserved	1	1	0	1	0	1	0	1	0	0
Local11	1	01011	Reserved	0	0	0	1	1	1	0	0	1	1
Local12	1	01100	Reserved	0	0	0	0	0	0	0	0	0	0
Local13	1	01101	Reserved	0	0	0	0	0	0	0	0	0	0
Local14	1	01110	Reserved	0	0	0	0	0	0	0	0	0	0
Local15	1	01111	Reserved	0	0	0	0	0	0	0	0	0	0
Local16	1	10000	Reserved	0	0	0	0	0	0	0	0	0	0
Local17	1	10001	Reserved	0	0	0	0	0	0	0	0	0	0
Local18	1	10010	Reserved	0	0	0	0	0	0	0	0	0	0
Local19	1	10011	Reserved	0	0	0	0	0	0	0	0	0	0
Local20	1	10100	Reserved	0	0	0	0	0	0	0	0	0	0
Local21	1	10101	Reserved	0	0	0	0	0	0	0	0	0	0
Local22	1	10110	Reserved	0	0	0	0	0	0	0	0	0	0
Local23	1	10111	Reserved	0	0	0	0	0	0	0	0	0	0
Local24	1	11000	Reserved	0	0	1	1	0	0	0	1	0	0
Local25	1	11001	Reserved	0	1	0	0	1	0	1	0	1	1
Local26	1	11010	Reserved	0	1	0	1	1	0	0	1	0	1
Local27	1	11011	W/R	RESERVED	TX_AMD_ BB_GAIN	TX_AMD_ <1:							
			Default	0	0	0	0	0	0	0	0	0	0
Local28	1	11100	Reserved	0	0	0	0	0	0	0	1	0	0
Local31	1	11111	Reserved	0	0	0	0	0	0	0	0	0	0

Table 3. Main Address 0: (A4:A0 = 00000)

BIT NAME	BIT LOCATION (D0 = LSB)	DESCRIPTION
RESERVED	D9	Reserved bits; set to default
E_TX<4:1>	D8:D5	Tx MIMO Channel Select Select Tx channels independently. 0 = Not select 1 = Select in Tx, Tx calibration, or RF loopback modes 1111 = Default
MODE<2:0>	D4:D2	IC Operating Mode Select 000 = Clockout (default) 001 = Standby 010 = Rx 011 = Tx 100 = Tx calibration 101 = RF loopback 11x = Baseband loopback
RFBW	D1	RF Bandwidth 0 = 20MHz 1 = 40MHz (default)
M/L_SEL	D0	Main or Local Address Select 0 = Main registers (default) 1 = Local registers

Table 4. Main Address 1: (A4:A0 = 00001, Main Address 0 D0 = 0)

BIT NAME	BIT LOCATION (D0 = LSB)	DESCRIPTION
RESERVED	D9:D8	Reserved bits; set to default
LNA_GAIN<2:0>	D7:D5	LNA Gain Control Active when Rx channel is selected by corresponding RX_PATH_UNMASK<5:1> bits in Main address 6 D9:D5. 000 = Maximum - 40dB 001 = Maximum - 32dB 100 = Maximum - 24dB 101 = Maximum - 16dB 110 = Maximum - 8dB 111 = Maximum gain (default)
VGA_GAIN<4:0>	D4:D0	Rx VGA Gain Control Active when Rx channel is selected by corresponding RX_PATH_UNMASK<5:1> bits in Main address 6 D9:D5. 00000 = Minimum gain 00001 = Minimum + 2dB 01110 = Minimum + 28dB 01111 = Minimum + 30dB 1xxxx = Minimum + 30dB (default)

Table 5. Main Address 2: (A4:A0 = 00010, Main Address 0 D0 = 0)

BIT NAME	BIT LOCATION (D0 = LSB)	DESCRIPTION
RESERVED	D9:D7	Reserved bits; set to default
LNA_BAND<1:0>	D6:D5	LNA Frequency Band Switch 00 = 4.9GHz~5.2GHz 01 = 5.2GHz~5.5GHz (default) 10 = 5.5GHz~5.8GHz 11 = 5.8GHz~5.9GHz
RESERVED	D4:D0	Reserved bits; set to default

Table 6. Main Address 3: (A4:A0 = 00011, Main Address 0 D0 = 0)

BIT NAME	BIT LOCATION (D0 = LSB)	DESCRIPTION
RESERVED	D9:D8	Reserved bits; set to default
TS_EN	D7	Temperature Sensor Enable 0 = Disable (default) 1 = Enable except shutdown or clockout mode
TS_TRIG	D6	Temperature Sensor Reading Trigger 0 = Not trigger (default) 1 = Trigger temperature reading
RESERVED	D5	Reserved bits; set to default
TS_READ<4:0>	D4:D0	SPI readback only. Temperature sensor reading.

Table 7. Main Address 5: (A4:A0 = 00101, Main Address 0 D0 = 0)

BIT NAME	BIT LOCATION (D0 = LSB)	DESCRIPTION
RESERVED	D9	Reserved bits; set to default
RSSI_MUX_SEL<2:0>	D8:D6	RSSI Output Select 000 = Baseband RSSI (default) 001 = Do not use 010 = Do not use 011 = Do not use 100 = Rx RF detector 101 = Do not use 110 = PA power-detector mux output 111 = Do not use
RESERVED	D5:D2	Reserved bits, set to default
RXHP	D1	Rx VGA Highpass Corner Select after Rx Turn-On RXHP starts at 1 during Rx gain adjustment, and set to 0 after gain is adjusted. 0 = 10kHz highpass corner after Rx gain is adjusted (default) 1 = 600kHz highpass corner during Rx gain adjustment
RESERVED	D0	Reserved bits; set to default

Table 8. Main Address 9: (A4:A0 = 01001, Main Address 0 D0 = 0)

BIT NAME	BIT LOCATION (D0 = LSB)	DESCRIPTION
TX_GAIN<5:0>	D9:D4	Tx VGA Gain Control Tx channel is selected by Main address 9 D3:D0. 000000 = Minimum gain (default) 111111 = Minimum gain + 31.5dB
TX_GAIN_PROG_SEL<4:1>	D3:D0	Tx Channel Gain Programming Select Gain is determined by Main address 9 D9:D4. 0 = Not selected 1 = Selected 1111 = Default

Table 9. Main Address 11: (A4:A0 = 01011, Main Address 0 D0 = 0)

BIT NAME	BIT LOCATION (D0 = LSB)	DESCRIPTION
RESERVED	D9:D4	Reserved bits; set to default
E_TX_AMD<1:0>	D3:D2	Tx Calibration AM Detector Channel Select Only active in Tx calibration mode. 00 = Select TX1 (default) 01 = Select TX2 10 = Select TX3 11 = Select TX4
PA_DET_SEL<1:0>	D1:D0	PA Power-Detector Mux Output Select 00 = Select PA_DET1 (default) 01 = Select PA_DET2 10 = Select PA_DET3 11 = Select PA_DET4

BIT NAME	BIT LOCATION (D0 = LSB)	DESCRIPTION
RESERVED	D9:D2	Reserved bits; set to default
DOUT_SEL	D1	DOUT Pin Output Select 0 = PLL lock detect (default) 1 = SPI readback
RESERVED	D0	Reserved bits; set to default

Table 11. Main Address 15: (A4:A0 = 01111, Main Address 0 D0 = 0)

BIT NAME	BIT LOCATION (D0 = LSB)	DESCRIPTION
VAS_TRIG_EN	D9	Enable VCO Sub-Band Acquisition Triggered by SYN_CONFIG_F<9:0> (Main Address 17) Programming 0 = Disable for small frequency adjustment (i.e., ~100kHz) 1 = Enable for channel switching (default)
RESERVED	D8:D7	Reserved bits; set to default
SYN_CONFIG_N<6:0>	D6:D0	Integer Divide Ratio 1000010 = Default

Table 12. Main Address 16: (A4:A0 = 10000, Main Address 0 D0 = 0)

BIT NAME	BIT LOCATION (D0 = LSB)	DESCRIPTION
SYN_CONFIG_F<19:10>	D9:D0	Fractional Divide Ratio MSBs 1110000000 = Default

Table 13. Main Address 17: (A4:A0 = 10001, Main Address 0 D0 = 0)

BIT NAME	BIT LOCATION (D0 = LSB)	DESCRIPTION
SYN_CONFIG_F<9:0>	D9:D0	Fractional Divide Ratio LSBs 0000000000 = Default

Table 14. Main Address 18: (A4:A0 = 10010, Main Address 0 D0 = 0)

BIT NAME	BIT LOCATION (D0 = LSB)	DESCRIPTION
RESERVED	D9:D8	Reserved bits; set to default
XTAL_TUNE<7:0>	D7:D0	Crystal Oscillator Frequency Tuning 00000000 = Minimum frequency 10000000 = Default 11111111 = Maximum frequency

Table 15. Main Address 19: (A4:A0 = 10011, Main Address 0 D0 = 0)

BIT NAME	BIT LOCATION (D0 = LSB)	DESCRIPTION
RESERVED	D9:D8	Reserved bits; set to default
VAS_RELOCK_SEL	D7	VAS Relock Select 0 = Start at sub-band selected by VAS_SPI<5:0> (Main address 19 D5:D0) (default) 1 = Start at current sub-band
VAS_MODE	D6	VCO Subband Select 0 = By VAS_SPI<5:0> (Main address 19 D5:D0) 1 = By on-chip VCO autoselect (VAS) (default)

Table 15. Main Address 19: (A4:A0 = 10011, Main Address 0 D0 = 0) (continued)

BIT NAME	BIT LOCATION (D0 = LSB)	DESCRIPTION
VAS_SPI<5:0>	D5:D0	VCO Autoselect Sub-Band Input Select VCO sub-band when VAS_MODE (Main address 19 D6) = 0. Select initial VCO sub-band for autoacquisition when VAS_MODE = 1. 000000 = Minimum frequency sub-band 011111 = Default 111111 = Maximum frequency sub-band
VAS_ADC<2:0> (Readback Only)	D8:D6	Read VCO Autoselect Tune Voltage ADC Output Active when VCO_VAS_RB (Main address 27 D5) = 1. 000 = Lower than lock range and at risk of unlock 001 = Lower than acquisition range and maintain lock 010 or 101 = Within acquisition range and maintain lock 110 = Higher than acquisition range and maintain lock 111 = Higher than lock range and at risk of unlock
VCO_BAND<5:0> (Readback Only)	D5:D0	Read the Current Acquired VCO Sub-Band by VCO Autoselect Active when VCO_VAS_RB (Main address 27 D5) = 1.

Table 16. Main Address 21: (A4:A0 = 10101, Main Address 0 D0 = 0)

BIT NAME	BIT LOCATION (D0 = LSB)	DESCRIPTION
RESERVED	D9:D0	Reserved bits; set to default
DIE_ID<2:0> (Readback Only)	D7:D5	Read Revision ID at Main Address 21 D7:D5 Active when DIE_ID_READ (Main address 27 D9) = 1. 000 = Pass1 001 = Pass2

Table 17. Main Address 27: (A4:A0 = 11011, Main Address 0 D0 = 0)

BIT NAME	BIT LOCATION (D0 = LSB)	DESCRIPTION
DIE_ID_READ	D9	Die ID Readback Select 0 = Main address 21 D9:D0 reads its own values (default) 1 = Main address 21 D7:D5 reads revision ID
RESERVED	D8:D6	Reserved bits, set to default
VAS_VCO_READ	D5	VAS ADC and VCO Sub-Band Readback Select 0 = Main address 19 D9:D0 reads its own values (default). 1 = Main address 19 D8:D6 reads VAS_ADC<2:0>; Main address 19 D5:D0 reads VCO_BAND<5:0>.
RESERVED	D4:D0	Reserved bits; set to default

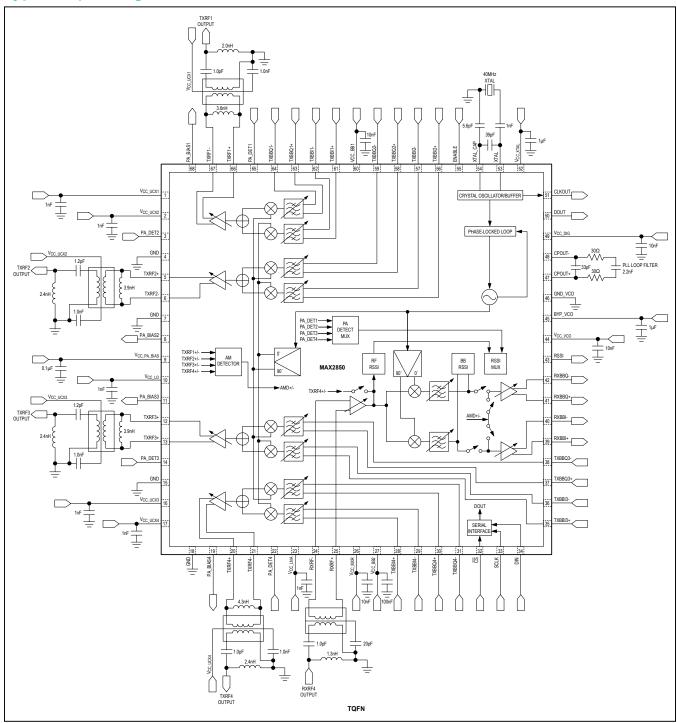
Table 18. Main Address 28: (A4:A0 = 11100, Main Address 0 D0 = 0)

BIT NAME	BIT LOCATION (D0 = LSB)	DESCRIPTION
RESERVED	D9:D4	Reserved bits; set to default
PA_BIAS_DLY<3:0>	D3:D0	PA_BIAS Turn-On Delay 0000 = 0μs 0001 = 0μs 0010 = 0.5μs 0011 = 1.0μs (default) 1111 = 7.0μs

Table 19. Local Address 27: (A4:A0 = 11011, Main Address 0 D0 = 1)

BIT NAME	BIT LOCATION (D0 = LSB)	DESCRIPTION
RESERVED	D9:D3	Reserved bits, set to default
TX_AMD_BB_GAIN	D2	Tx Calibration AM Detector Baseband Gain 0 = Minimum gain (default) 1 = Minimum gain + 5dB
TX_AMD_RF_GAIN	D1:D0	Tx Calibration AM Detector RF Gain 00 = Minimum gain (default) 01 = Minimum gain + 14dB rise at output 1x = Minimum gain + 28dB rise at output

Typical Operating Circuit



MAX2850

5GHz, 4-Channel MIMO Transmitter

Chip Information

PROCESS: BICMOS

Package Information

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
68 TQFN-EP	T6800+2	21-0142

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	10/09	Initial release	_
1	3/10	Modified EC table to support single-pass room test flow	2, 3, 5, 6, 8
2	1/19	Updated Absolute Maximum Ratings	2

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